In 0.5Ga0.5As quantum dot intermixing and evaporation in GaAs capping layer growth

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**In$_{0.5}$Ga$_{0.5}$As quantum dot intermixing and evaporation in GaAs capping layer growth**

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Our study of GaAs growth over self-assembled In$_{0.5}$Ga$_{0.5}$As quantum dots grown by metalorganic vapor-phase epitaxy showed that GaAs capping layer surface morphology at the onset strongly depended on temperature. Incompletely capped In$_{0.5}$Ga$_{0.5}$As islands were elongated toward [110], indicating anisotropy in intermixing. During higher-temperature growth interruption, islands show craters in quantum dot centers. Craters become hexagonal holes whose depth matches GaAs capping layer thickness. Postannealing photoluminescence spectra show no peak corresponding to overly large quantum dot radiation, indicating that growth interruption after capping layer formation at a certain thickness eliminates overly large quantum dots. © 1998 American Institute of Physics.

**I. INTRODUCTION**

Self-assembled islands formed in Stranski–Krastanow growth mode have attracted attention for use as quantum dot (QD) structures because potential ex situ pixellation damage and contamination are avoided.1,2 Despite extensive study on self-assembled QD growth and optical characterization, problems such as nonuniform size distribution and uncertain QD height remain,3 leading to discrepancies between observed quantization effects and theory. QD height fluctuation broadens photoluminescence (PL) peaks. Structural disorder such as intermixing during overlayer growth further complicates matters.4 Intermixing and evaporation change QD size, shape, and composition, resulting in discrepancies between expected and actual structure. Despite the importance of well-defined quantum structure fabrication, a few studies have focused on intermixing and evaporation during capping layer growth following QD formation.

This article details the intermixing and evaporation involving metalorganic vapor-phase epitaxy (MOVPE) used to grow In$_{0.5}$Ga$_{0.5}$As QDs during GaAs capping layer growth, focused on QD structure dependence on growth temperature ($T_g$) and capping layer thickness. Results show selective evaporation of exclusively high QDs, whose height exceeds the GaAs capping layer thickness. These results suggest that, to eliminate such undesirable QDs, the application of growth interruption following capping layer growth to a certain thickness would be feasible.

**II. EXPERIMENTS**

Our growth system is based on a conventional MOVPE system, Emcore Discovery 75. The working pressure was 80 hPa. Using 1400 rpm substrate rotation throughout the growth ensured the source gas flow. All the In$_{0.5}$Ga$_{0.5}$As QD samples were grown on GaAs (001) substrates at 480 °C.

Islands were capped by GaAs layer with or without interrupting growth at various $T_g$. Triethylgallium (TEG), trimethylindium (TMI), and arsine (AsH$_3$) were used as source materials. Flow rates of TEG and AsH$_3$ for GaAs were $6.65 \times 10^{-6}$ and $1.83 \times 10^{-3}$ mol/s, and TEG, TMI, and AsH$_3$ for In$_{0.5}$Ga$_{0.5}$As were $1.33 \times 10^{-6}$, $1.19 \times 10^{-6}$, and $1.83 \times 10^{-3}$ mol/s, respectively. The GaAs growth rate was $0.5$ monolayer (ML)/s and that of In$_{0.5}$Ga$_{0.5}$As was $0.2$ ML/s.

Surface morphologies were studied by atomic force microscopy (AFM) in air. Room temperature (RT) PL spectra was measured under excitation by an Ar$^+$ laser tuned to 488 nm.

**III. RESULTS AND DISCUSSIONS**

We began by studying intermixing dependence on QD size growing samples with large QD size distribution intentionally [Fig. 1(a)]. The QD size distribution in Fig. 1(a) is displayed in Fig. 2, showing a bimodal distribution. Similar bimodal QD size distribution has also been reported on InAs QDs grown on (001) substrates.5 The average height and diameter of smaller QDs are 80 and 320 Å. Larger QDs are about $110$ Å in height and 400 Å in diameter, respectively. A GaAs overlayer was grown at the different $T_g$ of 480 °C. Island density in uncapped [Fig. 1(a)] and capped samples was similar, indicating that In$_{0.5}$Ga$_{0.5}$As QDs originated the islands. Islands are elongated toward the [110] azimuth, being two times larger in the [110] direction. Moreover, the islands have craters at their centers that clearly become holes in larger QDs. Craters and holes make islands lower than as-grown QDs. All of these features indicate intermixing at the interface between the In$_{0.5}$Ga$_{0.5}$As QD and GaAs capping layer. Intermixing is assumed to be enhanced at larger QDs because of the higher In composition at the
interface due to segregation or larger dislocation density, hence, the holes. The above features also suggest the occurrence of evaporation, discussed later.

Craters and holes did not form when the GaAs capping layer was grown at lower $T_g$ (450 °C) as shown in Fig. 1. and QDs were about the same height despite increased island shape diameter and anisotropy. Island size anisotropy appears to be related to anisotropy in intermixing and in migration length of Ga precursors. This is distinguished easily because island height decreases simultaneously with intermixing. Thus, the anisotropy in diameter is due mainly to the anisotropy of overlayer growth rate, as suggested by similar island height. Island elongation toward $[110]$ agrees well with anisotropy in the migration length of Ga precursors in MOVPE growth. A flat surface is attained when QD embedding completed as seen in Fig. 1(d).

Unique phenomena also occur after growth interruption at higher temperature, i.e., annealing, after growing the GaAs capping layer thinner than QDs height. Figure 3(a) shows the surface AFM image of the annealed QD sample with 100-Å-thick GaAs capping layer grown at 450 °C. The annealing temperature and time are 640 °C and 1 min, respectively. The AFM image presents surface morphology, which consists of flat regions and holes. In the sample surface immediately after capping layer growth (not shown), the holes cannot be seen but mound-like islands occur in the place of holes. QDs higher than 100 Å in Fig. 1(a) and holes show similar density. The AFM profile also shows that hole depths are consistent with capping layer thickness. Thus, QDs originate in QDs higher than the capping layer. Evaporation following atom intermixing and redistribution with migration at the top of the exposed QD cause holes to form. Mounds on both sides (in the $[110]$ direction) of holes present rough images of QD structure intermixing and evaporation as is shown in Fig. 2(a). These mounds are assumed to consist of atoms composing QDs. During annealing, QD region atoms creep and migrate on the surface. Although most atoms eventually evaporate, they leave their trace behind in the form of mounds. These atoms are strongly directed toward the $[110]$ azimuth, coinciding with island shape anisotropy caused by anisotropy in Ga precursor migration length.

Holes twice the size of as-grown QDs evidence considerable intermixing in embedded region due to high annealing temperature, i.e., intermixing occurs even in fully embedded QDs, broadening the PL peak. The clearly hexagonal hole shape indicates facet formation. The AFM profile for different directions indicates that hole sidewalls consist of $\{111\}$ and $\{110\}$ facets. Why facets form is unclear, but facets resemble those in mesa etching. Stable states appear to exist at low Miller index planes that resist intermixing or re-evaporation. The participation of dislocation may also be a factor.

When the same process is conducted for samples with a thinner capping layer, large holes occur on the surface as seen in Fig. 3(b). The increased number of incompletely capped In$_{0.3}$Ga$_{0.7}$As islands increases hole density. As holes coalesce, large holes form in thinner capping layer. The flat bottoms of holes whose depths match capping layer thick-
ness further support the idea of hole formation following intermixing and evaporation. Thus, annealing after capping layer growth at a specified thickness would eliminate overly large QDs.

Figure 4 shows the RT PL spectra of annealed and unannealed In$_{0.5}$Ga$_{0.5}$As QD samples following 100 Å GaAs capping layer growth at 450 °C. For the annealed sample, $T_g$ was set to conventional GaAs growth of 640 °C and a 300-Å-thick GaAs overlayer was grown. For the unannealed sample, a 150-Å-thick GaAs capping layer was grown at 450 °C before $T_g$ was set to 640 °C to grow the 200-Å-thick GaAs layer. Three peaks occur for the unannealed sample. The peak at 1.218 eV is for a wetting layer. The relatively large linewidth in the wetting layer peak is due to the large fluctuation in layer thickness. From the result of excitation power dependent PL measurement, the peaks at 1.017 and 1.058 eV were confirmed to be the radiation from the QDs with bimodal size distribution as was shown in Fig. 2. Since the peak at 1.058 eV was clearly distinguishable under low excitation power of 0.1 W/cm$^2$, the peak does not originate from higher energy subband of the peak at 1.017 eV but originates from the ground state of smaller QDs (data not shown). Similar PL result reflecting bimodal QD size distribution has been reported by Yu $et al.$ In the PL spectra of annealed sample, the peak at 1.017 eV disappeared whereas no change was observed in the peak at 1.058 and 1.218 eV. The peaks at 1.058 and 1.218 eV originate from the fully embedded QDs and wetting layer by the GaAs capping layer before annealing. The structures keep their shape during the annealing because they are protected by the GaAs capping layer. Consequently, no difference was seen in the PL spectra of annealed and unannealed samples. On the other hand, the peak at 1.017 eV is considered to be the radiation from the larger QDs (110 Å in height). Since the larger QDs are taller than the 100-Å-thick GaAs capping layer, top of the QD structures were exposed on the surface. Therefore, evaporation of the larger QDs was enhanced during annealing and the QDs eliminate as was confirmed in Fig. 3(a). It is the reason why the PL peak at 1.017 eV disappears after annealing. These results indicate that size uniformity can be improved by selectively evaporating overly large QDs using a certain GaAs capping layer thickness and $T_g$.

IV. CONCLUSIONS

Intermixing and evaporation during GaAs capping layer growth over MOVPE grown self-assembled In$_{0.5}$Ga$_{0.5}$As QDs were studied. In$_{0.5}$Ga$_{0.5}$As islands partially capped by GaAs layer showed "craters" at QD centers at higher GaAs growth temperature. Craters become clearly hexagonal holes whose depths corresponded to GaAs capping layer thickness after annealing indicating that QDs higher than the capping layer were evaporated by annealing. Postannealing PL spectra show no peak corresponding to overly large QD radiation, indicating that growth interruption after capping layer formation at a certain thickness eliminates overly large QDs. The results indicate that the annealing technique can be used to select QD size distribution.